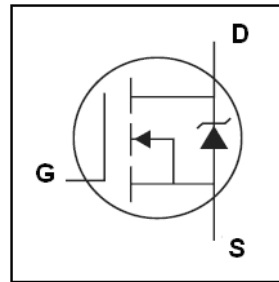


**Features**

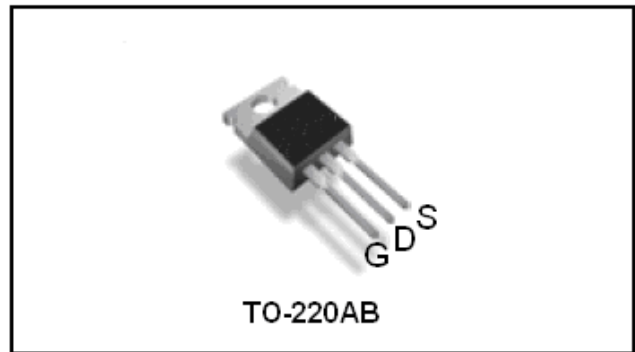
- ◆ Low On-Resistance
- ◆ Fast Switching
- ◆ 100% Avalanche Tested
- ◆ Repetitive Avalanche Allowed up to  $T_{jmax}$
- ◆ Lead-Free, RoHS Compliant

**Description**

VS4410AT designed by the trench processing techniques to achieve extremely low on-resistance. Additional features of this design are a 175°C junction operating temperature, fast switching speed and improved repetitive avalanche rating . These features combine to make this design an extremely efficient and reliable device for use in Motor applications and a wide variety of other applications.



$V_{DSS}$	100V
$R_{DS(on)}$	6.5m $\Omega$
$I_D$	110A


**Absolute Maximum Ratings**

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature ( $T_A$ ) is 25°C, unless otherwise specified.

Symbol	Parameter	Rating	Unit
<b>Common Ratings (<math>T_C=25^\circ\text{C}</math> Unless Otherwise Noted)</b>			
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	100	V
$T_J$	Maximum Junction Temperature	175	$^\circ\text{C}$
$T_{STG}$	Storage Temperature Range	-55 to 175	$^\circ\text{C}$
$I_S$	Maxium Diode Continuous Forward Current	$T_C=25^\circ\text{C}$ 110	A
<b>Mounted on Large Heat Sink</b>			
$I_{DM}$	Pulse Drain Current Tested ①	$T_C=25^\circ\text{C}$ 370	A
$I_D$	Continuous Drain current@ $V_{GS}=10\text{V}$	$T_C=25^\circ\text{C}$ 110	A
$P_D$	Maximum Power Dissipation	$T_C=25^\circ\text{C}$ 250	W
$R_{\theta JC}$	Thermal Resistance-Junction to Case	0.58	$^\circ\text{C/W}$
$R_{\theta JA}$	Thermal Resistance Junction-Ambient	62.5	$^\circ\text{C/W}$
<b>Drain-Source Avalanche Ratings</b>			
EAS	Avalanche Energy, Single Pulsed ②	900	mJ

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
<b>Static Electrical Characteristics @ T<sub>J</sub> = 25°C (unless otherwise stated)</b>						
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V I <sub>D</sub> =250μA	100	110	--	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current(Tc=25°C)	V <sub>DS</sub> =100V,V <sub>GS</sub> =0V	--	--	1	μA
	Zero Gate Voltage Drain Current(Tc=125°C)	V <sub>DS</sub> =100V,V <sub>GS</sub> =0V	--	--	100	μA
I <sub>GSS</sub>	Gate-Body Leakage Current	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V	--	--	±100	nA
V <sub>GS(TH)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =250μA	2	--	4	V
R <sub>DS(ON)</sub>	Drain-Source On-State Resistance <sup>③</sup>	V <sub>GS</sub> =10V, I <sub>D</sub> =60A	--	6.5	8	mΩ
<b>Dynamic Electrical Characteristics @ T<sub>J</sub> = 25°C (unless otherwise stated)</b>						
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =50V,V <sub>GS</sub> =0V, f=1MHz	--	6050	--	pF
C <sub>oss</sub>	Output Capacitance		--	560	--	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		--	205	--	pF
Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> =50V,I <sub>D</sub> =75A, V <sub>GS</sub> =10V	--	120	--	nC
Q <sub>gs</sub>	Gate-Source Charge		--	26	--	nC
Q <sub>gd</sub>	Gate-Drain Charge		--	30	--	nC
<b>Switching Characteristics</b>						
t <sub>d(on)</sub>	Turn-on Delay Time	V <sub>DD</sub> =60V, I <sub>D</sub> =30A, R <sub>G</sub> =2.8Ω, V <sub>GS</sub> =10V	--	21	--	nS
t <sub>r</sub>	Turn-on Rise Time		--	50	--	nS
t <sub>d(off)</sub>	Turn-Off Delay Time		--	46	--	nS
t <sub>f</sub>	Turn-Off Fall Time		--	60	--	nS
<b>Source- Drain Diode Characteristics @ T<sub>J</sub> = 25°C (unless otherwise stated)</b>						
I <sub>SD</sub>	Source-drain current(Body Diode)	T <sub>c</sub> =25°C	--	--	110	A
V <sub>SD</sub>	Forward on voltage	I <sub>SD</sub> =50A,V <sub>GS</sub> =0V	--	0.86	1.3	V
t <sub>rr</sub>	Reverse Recovery Time	T <sub>J</sub> =25°C,I <sub>SD</sub> =75A, V <sub>GS</sub> =0V	--	50	--	nS
Q <sub>rr</sub>	Reverse Recovery Charge	di/dt=100A/μs		105		nC

**NOTE:**

① Pulse width ≤ 300μs; duty cycle ≤ 2%; pulse width limited by max. junction temperature.

② Limited by T<sub>Jmax</sub>, starting T<sub>J</sub> = 25°C, L = 0.5mH,R<sub>G</sub> = 25Ω, I<sub>AS</sub> =50A, V<sub>GS</sub> =10V.

Typical Characteristics

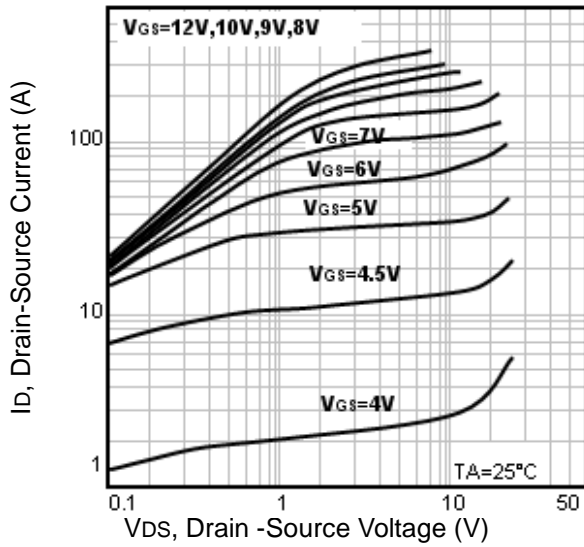


Fig1. Typical Output Characteristics

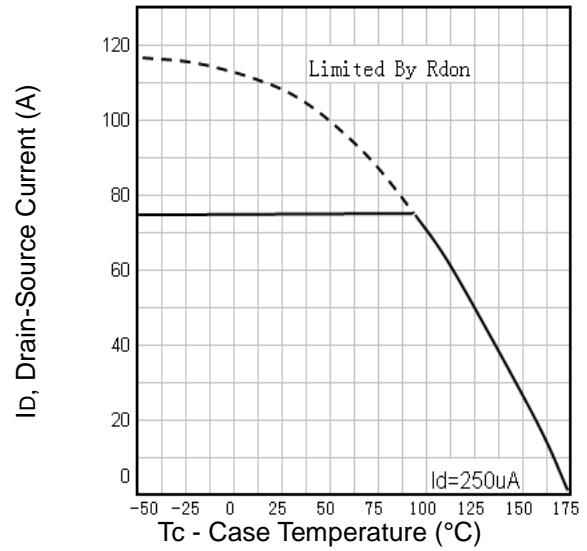


Fig2. Maximum Drain Current Vs. Case Temperature

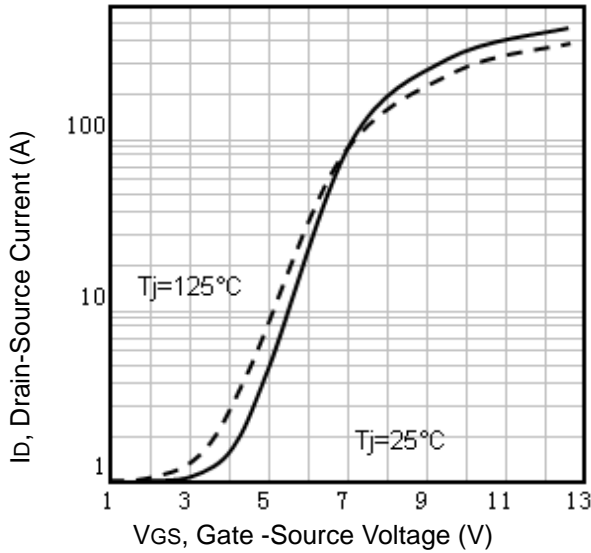


Fig3. Typical Transfer Characteristics

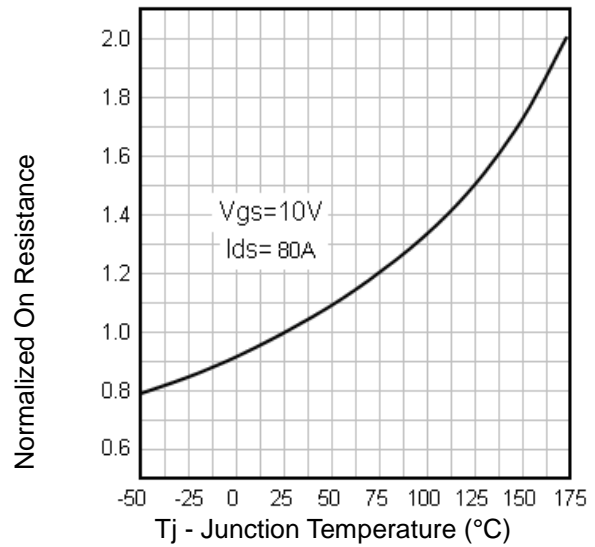


Fig4. Normalized On-Resistance Vs. Temperature

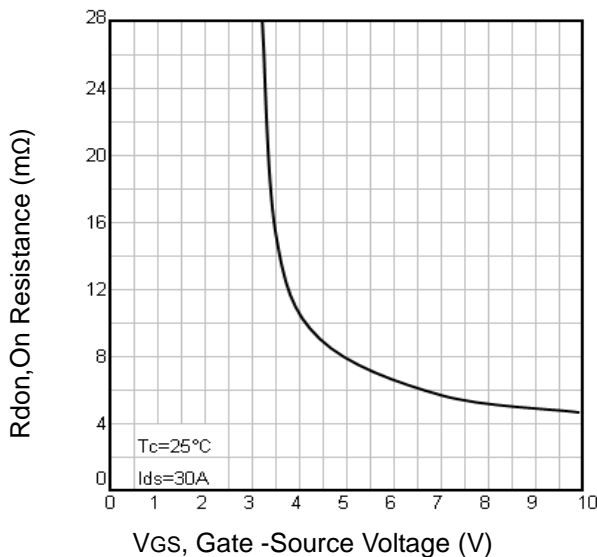


Fig5. Typical On-Resistance Vs. Gate-Source Voltage

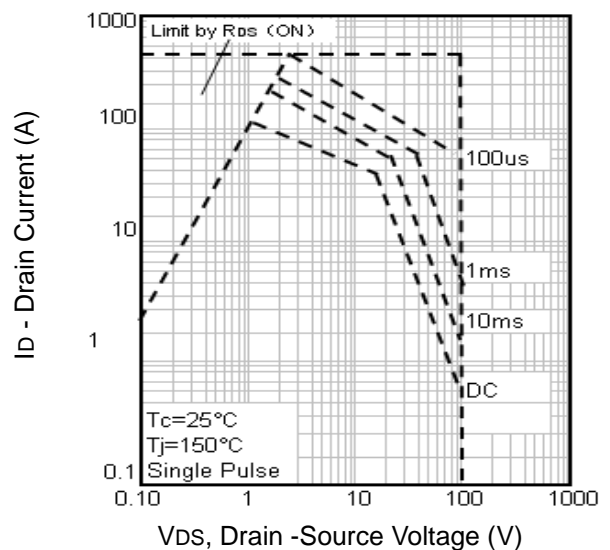


Fig6. Maximum Safe Operating Area

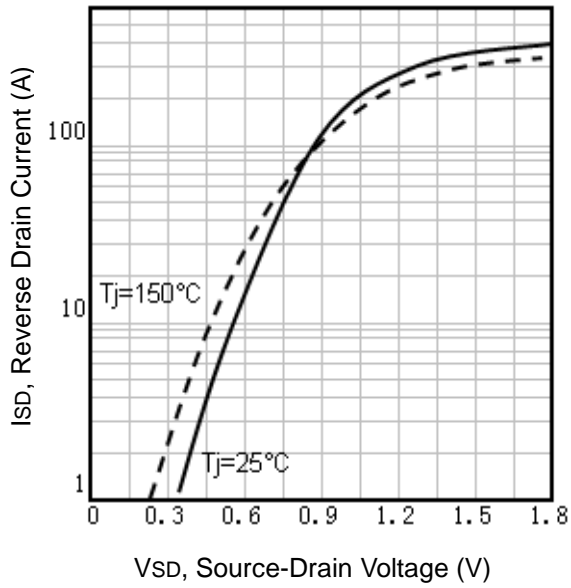


Fig7. Typical Source-Drain Diode Forward Voltage

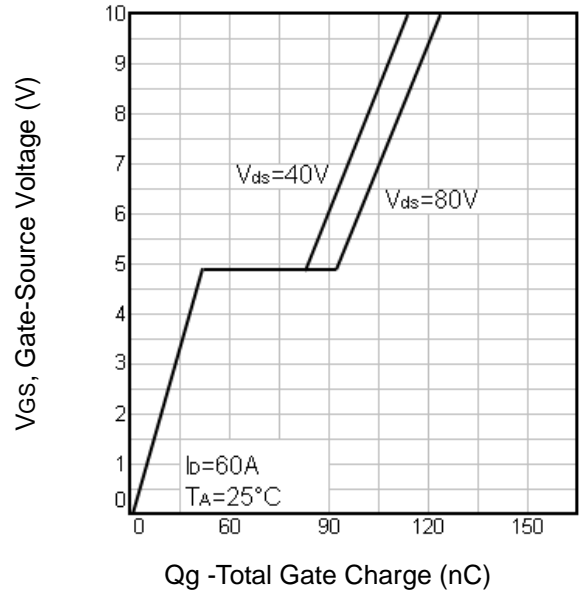


Fig8. Typical Gate Charge Vs. Gate-Source Voltage

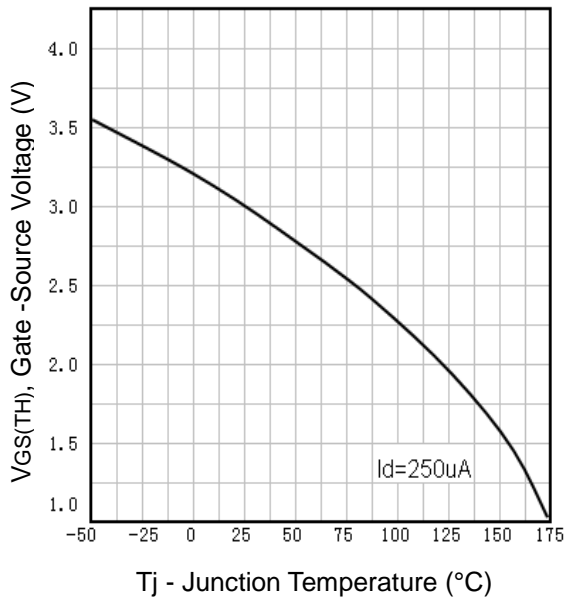


Fig9. Threshold Voltage Vs. Temperature

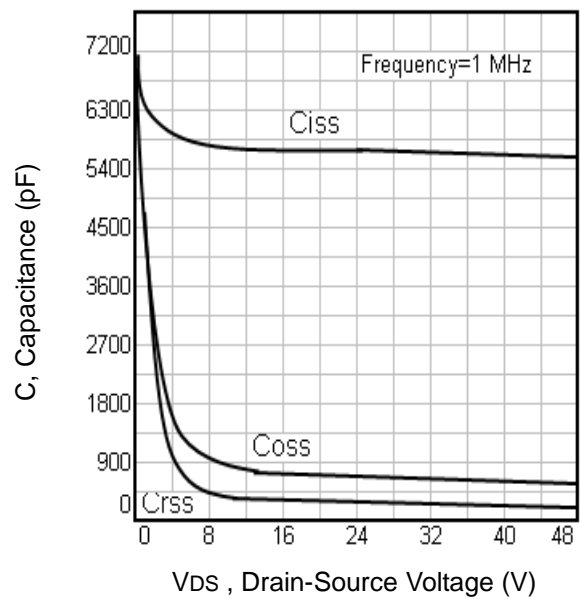


Fig10. Typical Capacitance Vs. Drain-Source Voltage

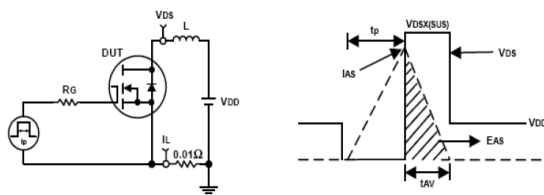


Fig11. Unclamped Inductive Test Circuit and waveforms

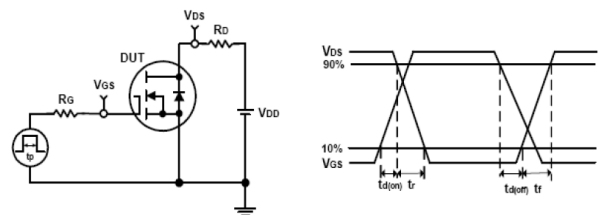
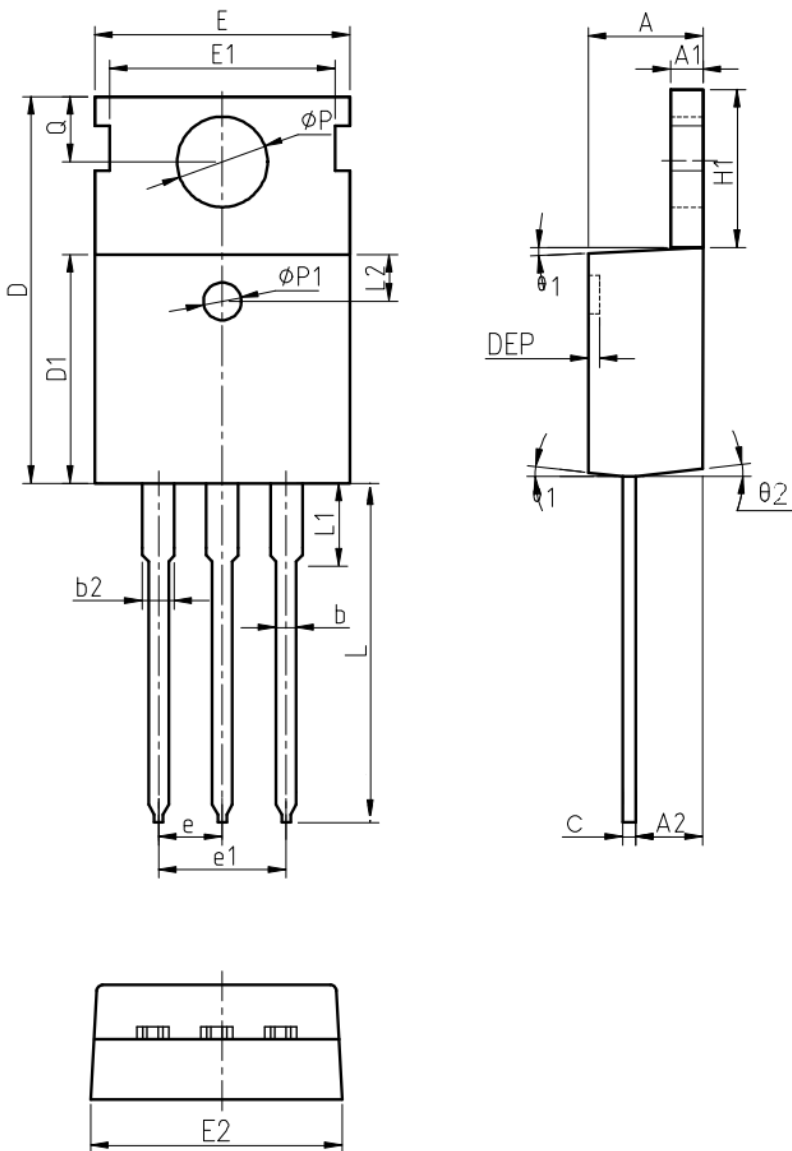


Fig12. Switching Time Test Circuit and waveforms

## TO-220AB Package Outline Data



Symbol	Dimensions (unit: mm)		
	Min	Typ	Max
<b>A</b>	4.30	4.52	4.70
<b>A1</b>	1.15	1.30	1.40
<b>A2</b>	2.20	2.40	2.60
<b>b</b>	0.70	0.80	1.00
<b>b2</b>	1.17	1.32	1.50
<b>c</b>	0.45	0.50	0.61
<b>D</b>	15.30	15.65	15.90
<b>D1</b>	9.00	9.20	9.40
<b>DEP</b>	0.05	0.10	0.25
<b>E</b>	9.66	9.90	10.28
<b>E1</b>	-	8.70	-
<b>E2</b>	9.80	10.00	10.20
$\phi P1$	1.40	1.50	1.60
<b>e</b>	2.54 BSC		
<b>e1</b>	5.08 BSC		
<b>H1</b>	6.40	6.50	6.80
<b>L</b>	12.70	-	14.27
<b>L1</b>	-	-	3.95
<b>L2</b>	2.40	2.50	2.60
$\phi P$	3.53	3.60	3.70
<b>Q</b>	2.70	2.80	2.90
$\theta1$	5 °	7 °	9 °
$\theta2$	1 °	3 °	5 °

### Notes:

1. Refer to JEDEC TO-220 variation AB
2. Dimension "D" and "E" do NOT include mold flash. Mold flash shall not exceed 0.127mm per side.

## Customer Service

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